

BRC5N50ZC

Rev.A Jul.-2024

PDFN5×6 N

N-Channel MOSFET in a PDFN5×6 Plastic Package.

$V_{DS}(V)=500V$ $I_D=3A$

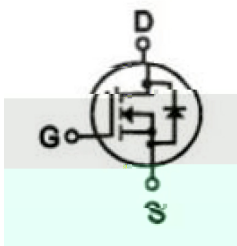
$R_{DS(ON)}@10V<1.6$ (Typ. 1.5)

$R_{DS(ON)}@6V<2.0$ (Typ. 1.6)

HF Product.

LED

Used in high-frequency switching power supply, electronic ballast, LED power supply and high-speed air duct.



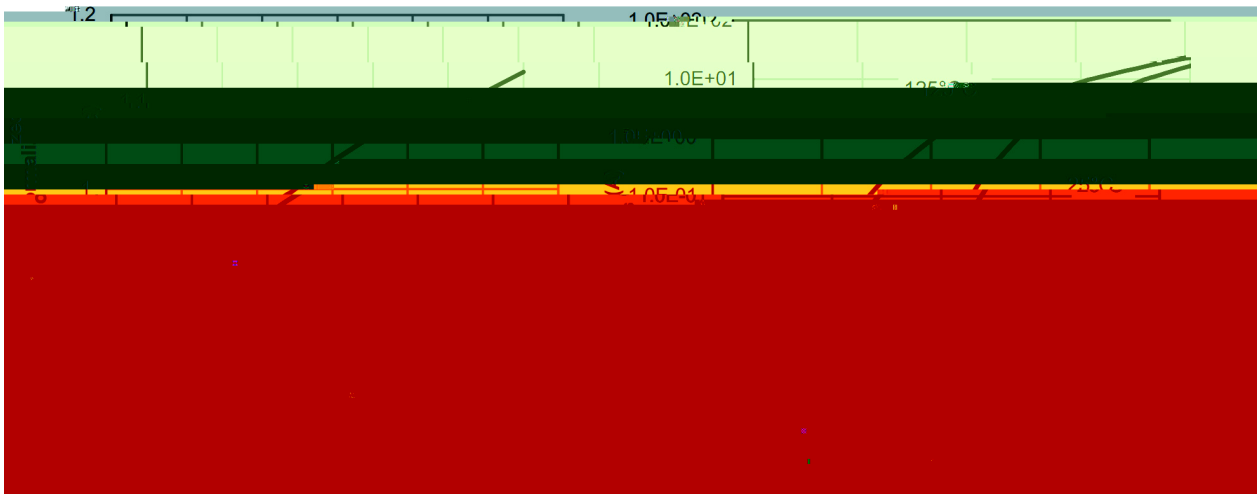
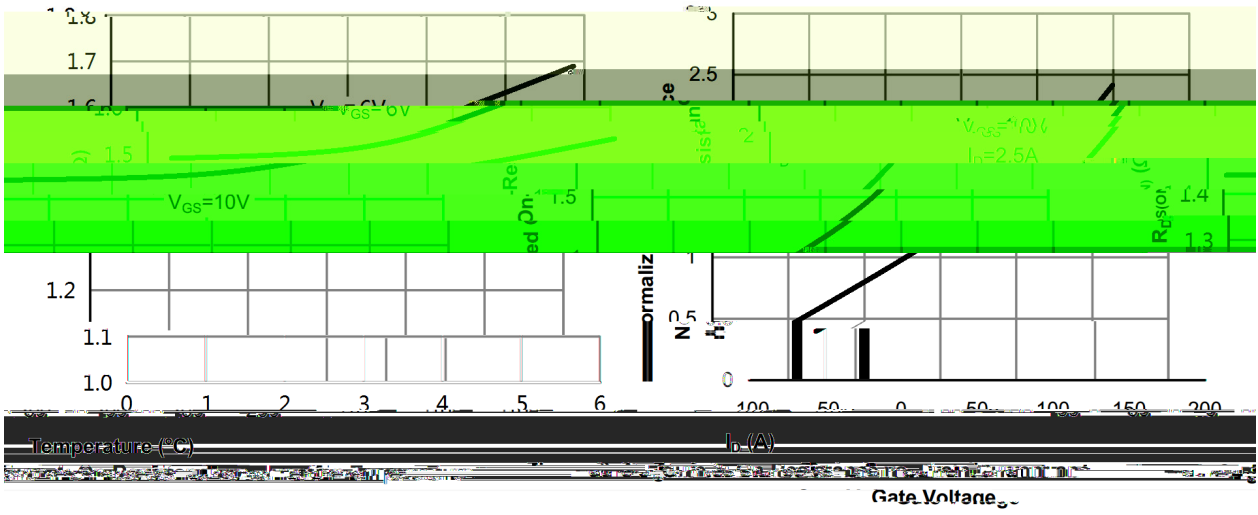
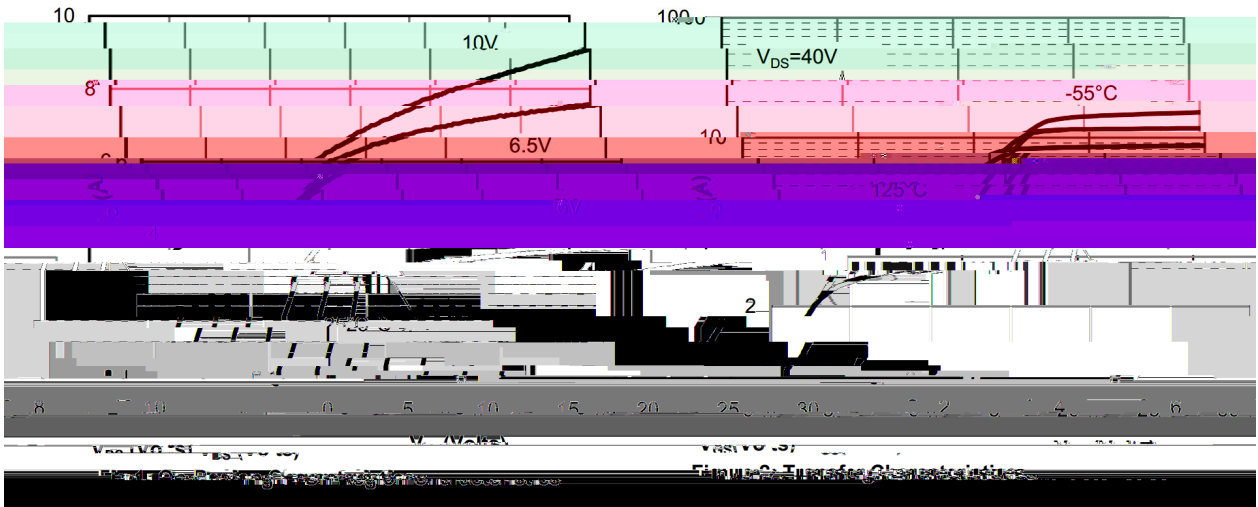
/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSS}	500	V
Drain Current	I _D (T _C =25)	3	A
Drain Current - Pulsed	I _{DM}	9.2	A
Gate-Source Voltage	V _{GSS}	±30	V
Avalanche Current	I _{AR}	7	A
Single Pulsed Avalanche Energy	E _{AS}	218	mJ
Power Dissipation (T _C =25)	P _D	33	W
Operating and Storage Temperature Range	T _J ,T _{STG}	-55 to 150	
Thermal resistance,Junction to Case	R _{θJC}	3.79	/ W

/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	500	560		V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =500V V _{GS} =0V			1	μA
Gate-Body Leakage Current Forward	I _{GSS}	V _{GS} =±30V V _{DS} =0V			±0.1	μA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =250μA	2	3.2	4	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V I _D =2.5A		1.5	1.6	
	R _{DS(on)}	V _{GS} =6V I _D =1A		1.6	2.0	
Input Capacitance	C _{ISS}	V _{DS} =25V V _{GS} =0V f=1.0MHz		570		pF
Output Capacitance	C _{OSS}			150		pF
Reverse Transfer Capacitance	C _{RSS}			10		pF
Total Gate Charge	Q _G	V _{DS} = 400V, I _D = 5.0A, V _{GS} = 10V		25		nC
Gate-Source Charge	Q _{GS}			6		
Gate-Drain Charge	Q _{GD}			8		

/ Electrical Characteristic Curve



/ Electrical Characteristic Curve

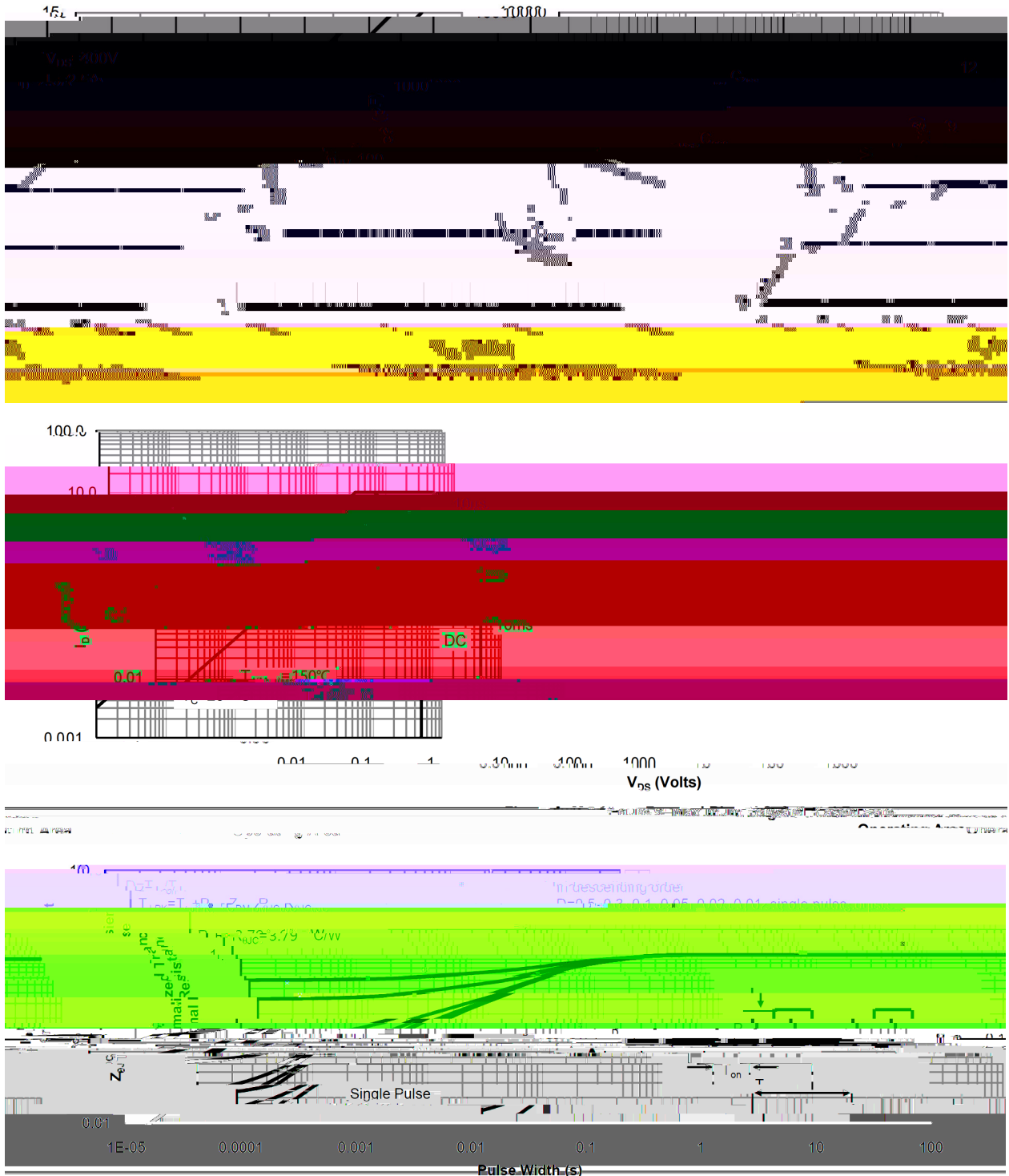


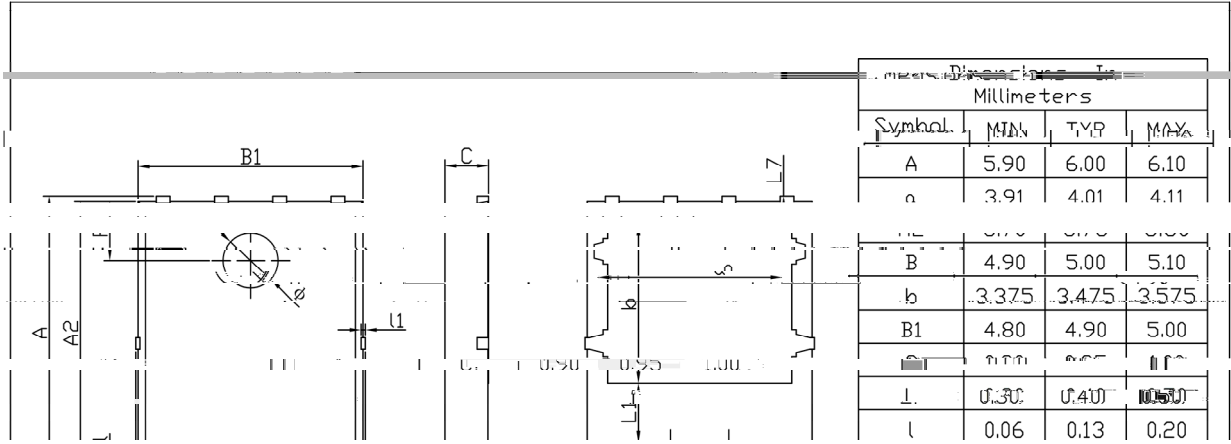
Figure 10: Normalized Maximum Transient Thermal Impedance

/ Package Dimensions

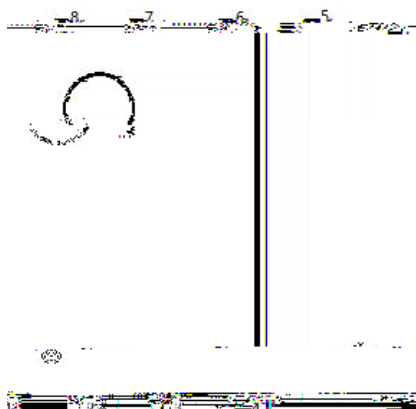
B

PDFN5 × 6

Unit:mm



/ Marking Instructions



BR
5N50

Note
5N50

